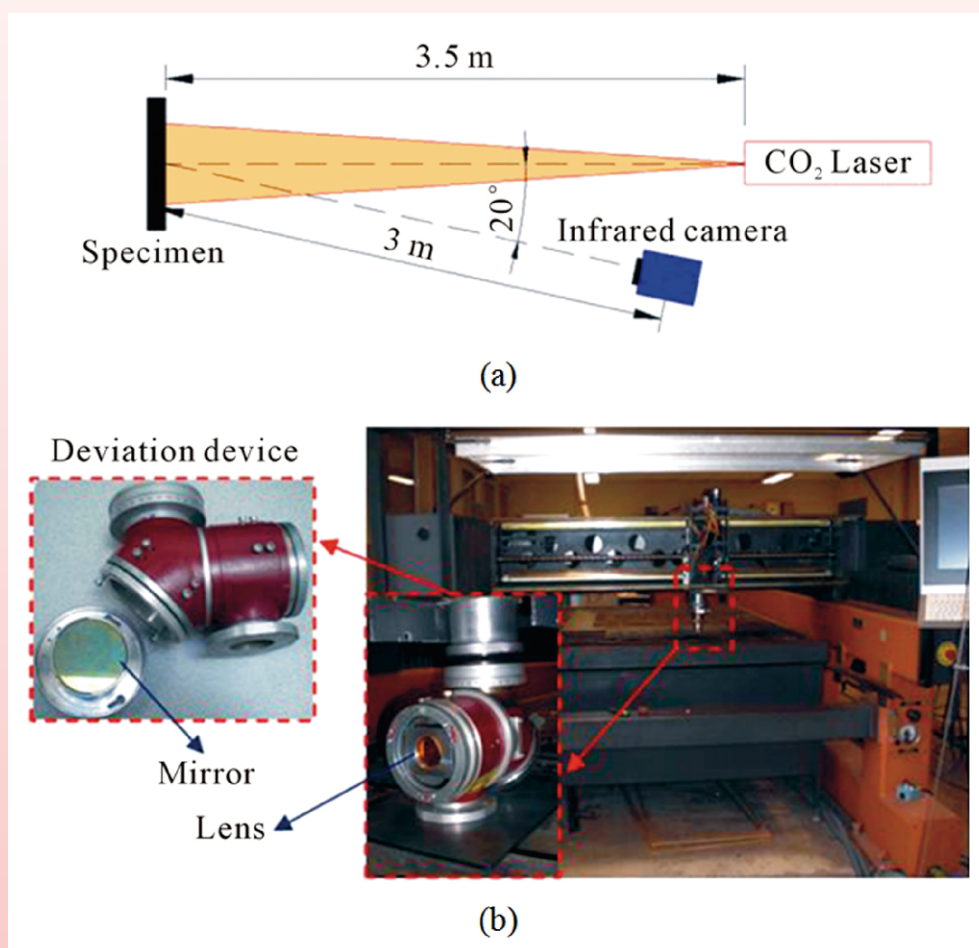


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ISSN: 2153-117X



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ISSN 2153-117X (Print) ISSN 2153-1188 (Online)

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The figure on the front cover is from the article published in *Materials Sciences and Applications*, 2013, Vol. 4, No. 10, pp. 600-605 by Sam-Ang Keo, Didier Defer, Florin Breaban and Franck Brachelet.

Materials Sciences and Applications (MSA)

Journal Information

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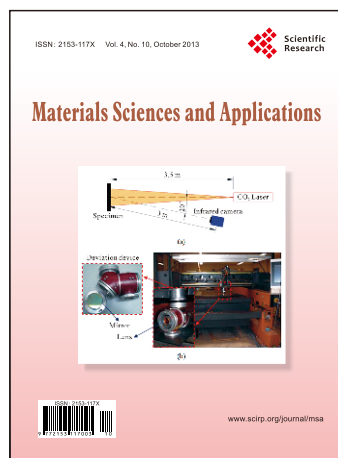
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ISSN 2153-117X (Print) ISSN 2153-1188 (Online)

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